# **SMB1N-850D**

- Infrared High Power LED
- 850 nm, 780 mW
- AlGaAs chip, 1000 x 1000 μm
- PA9T SMD package
- Beam Angle: ± 65°



## Description



**SMB1N-850D** is a surface mount AlGaAs based high power infrared LED, with a typical peak wavelength of 850 nm and optical output power of 780 mW @ 1 A. It comes in polyamide resin SMD package (PA9T) with silver plated soldering pads (lead free solderable), copper heat sink, and silicone resin mold. Additional variants with different beam angles are available on request.

## Maximum Ratings\*

Parameter	Symbol	Va	Unit	
Faranietei	Symbol	Min.	Max.	Offic
Power Dissipation	PD		2500	mW
Forward Current	<b>I</b> F		1000	mA
Pulse Forward Current **	<b>I</b> FP		3000	mA
Reverse Voltage	<b>U</b> R		5	V
Reverse Current (V <sub>R</sub> =5V)	<b>I</b> <sub>R</sub>		10	μΑ
Thermal Resistance	RTHJA		10	K/W
Junction Temperature	TJ		120	°C
Operating Temperature	TCASE	- 40	+ 100	°C
Storage Temperature	T <sub>STG</sub>	- 40	+ 100	°C
Lead Solder Temperature (t <sub>max</sub> . 5s)	T <sub>SLD</sub>		+ 250	°C

<sup>\*</sup>Operating close to or exceeding these parameters may damage the device

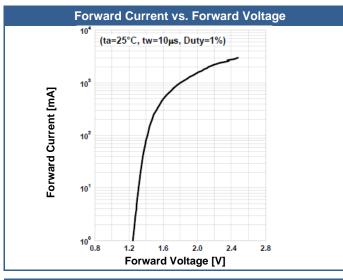
# Electro-Optical Characteristics (TCASE = 25°C)

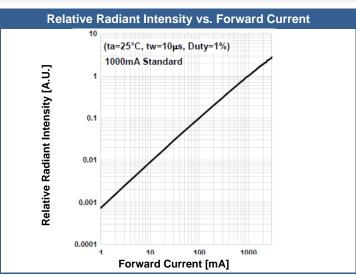
Parameter	Symbol	Conditions	Min.	Values Typ.	Max.	Unit
Peak Wavelength	$\lambda_P$	I <sub>F</sub> =1 A	840		865	nm
Half Width	$\lambda_{\Delta}$	I <sub>F</sub> =1 A		37		nm
Forward Voltage	$U_F$	I <sub>F</sub> =1 A		1.8	2.5	V
	UFP	I <sub>FP</sub> =3 A*		2.5		
Total Radiated Power	Po	I <sub>F</sub> =1 A	470	780		mW
		I <sub>FP</sub> =3 A*		2100		
Radiant Intensity	lE	I <sub>F</sub> =1 A		260		mW/sr
		IFP=3 A*		700		
Beam Angle	2θ <sub>1/2</sub>	$I_F=100 \text{ mA}$		130		deg.
Rise Time	$t_r$	I <sub>F</sub> =1 A		35		ns
Fall Time	t <sub>f</sub>	I <sub>F</sub> =1 A		20		ns

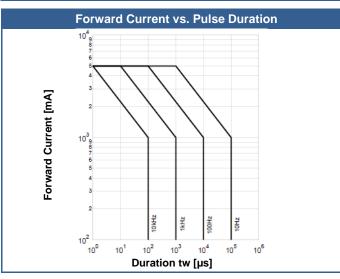
<sup>\*</sup> duty cycle = 1 %, pulse width = 10  $\mu$ s

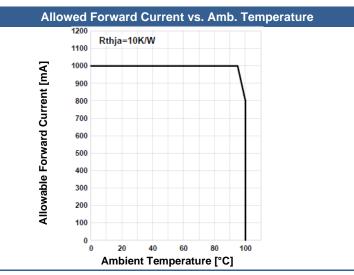
<sup>\*\*</sup> duty cycle = 1 %, pulse width = 10  $\mu$ s

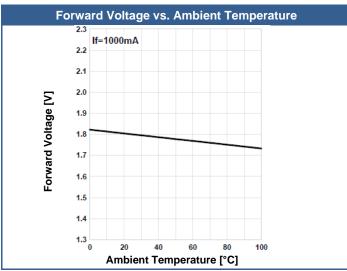
# **Typical Performance Curves**

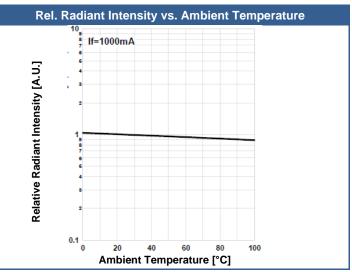




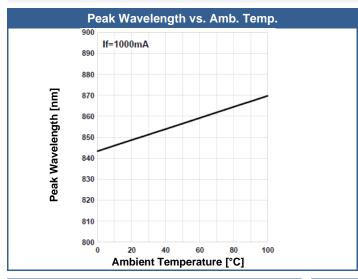


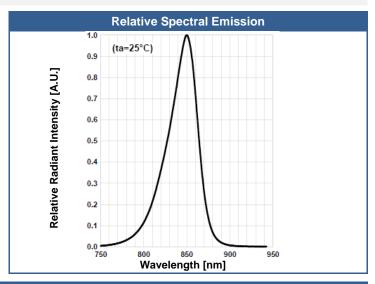


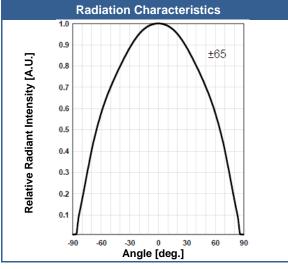


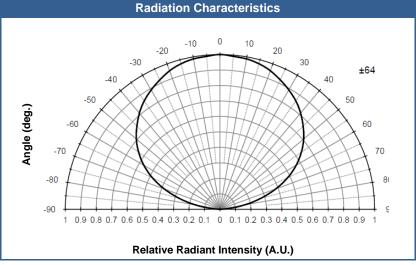


# **Typical Performance Curves**

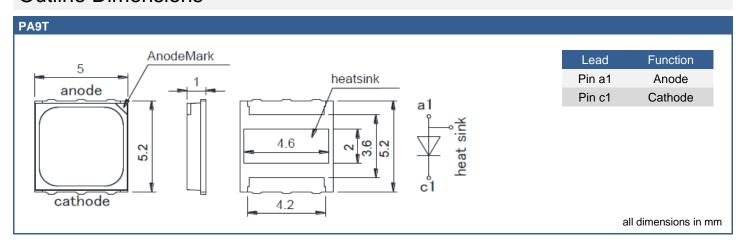








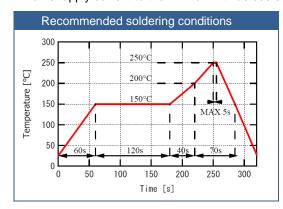
### **Outline Dimensions**

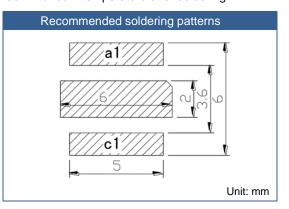


### **General Notes**

#### Soldering

- · Do avoid overheating of the LED
- Do avoid electrostatic discharge (ESD)
- Do avoid mechanical stress, shock, and vibration
- Do only use non-corrosive flux
- . Do not apply current to the LED until it has cooled down to room temperature after soldering





#### Cleaning

- . Cleaning with isopropyl alcohol, propanol, or ethyl alcohol is recommended
- DO NOT USE acetone, chloroseen, trichloroethylene, or MKS
- DO NOT USE ultrasonic cleaners

#### Static Electricity

- LEDs are sensitive to electrostatic discharge (ESD).
- Precautions against ESD must be taken when handling or operating these LEDs
- Surge voltage or electrostatic discharge can result in complete failure of the LED.

#### Radiation

- During operation these LEDs do emit light, which could be hazardous to skin and eyes, and may cause cancer.
- · Do avoid exposure to the emitted light. Protective glasses if needed
- It is further advised to attach a warning label on products/systems.

#### Operation

- · Do only operate LEDs with a current source.
- Running these LEDs from a voltage source will result in complete failure of the device.
- Current of a LED is an exponential function of the voltage across it. Usage of current regulated drive circuits is mandatory.

#### Storage

- The maximum shelf life of LEDs in the originally sealed aluminum bag is 12 months.
- Before opening the aluminum bag, please store it at <30 °C, <60 % RH.
- After opening the aluminum bag, please solder the LEDs within 72 hours (floor life) at 5 − 30 °C, <50 % RH.</li>
- Put any unused, remaining LEDs and silica gel back in the same aluminum bag and then vacuum-seal the bag.
- It is recommended to keep the re-sealed bag in a desiccator at <30%RH.</li>

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